CRMQTL0312A

N-Channel 30V, 9mΩ Typ. Power MOSFET

Description

Features

• 30V, 20A

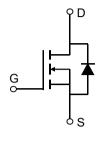
$$R_{DS(ON)}$$
 Typ = $9m\Omega$ @ V_{GS} = $10V$

$$R_{DS(ON)}$$
 Typ = 15m Ω @ V_{GS} = 4.5 V

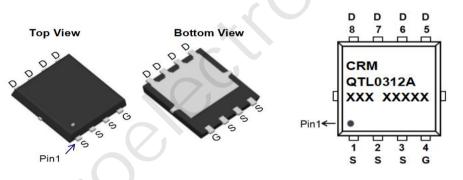
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Initial Version: 1.2

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMQTL0312A	CRMQTL0312A	PDFN3.3x3.3-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	20	Α
I _D	Continuous Drain Current	T _C = 100°C	12	А
I _{DM}	Pulsed Drain Current (1)		80	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		30	mJ
P_{D}	Power Dissipation	T _C = 25°C	8.3	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		15	°C/W
T_{J} , T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.1	1.6	2.1	V
D	Static Drain Source ON Designation of (3)	$V_{GS} = 10V, I_D = 15A$	-	9	12	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 4.5V, I_D = 10A$	-	15	20	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(805	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X - \	103	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112	- 1	82	-	pF
Q_g	Total Gate Charge		J -	16	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_D = 15A$	-	3.6	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 10 V, 1 _D = 10 A	-	3.4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	.r ()	-	6	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	16	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_D = 15A, R_{GEN} = 3Ω	-	17	-	ns
$t_{\rm f}$	Turn-Off Fall Time		-	5	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	20	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	80	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 10A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 400 4:/44 - 4004/	-	9.4	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 13A$, di/dt = 100A/us	_	3.3	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =11A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

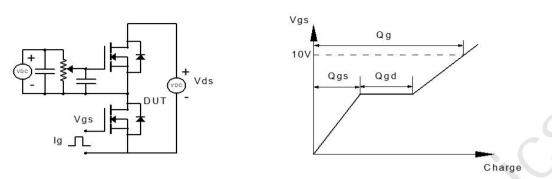


Figure 1: Gate Charge Test Circuit & Waveform

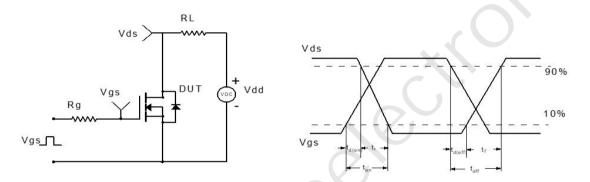


Figure 2: Resistive Switching Test Circuit & Waveform

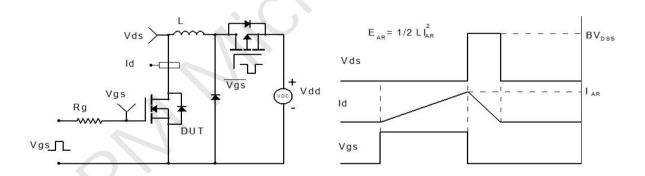


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

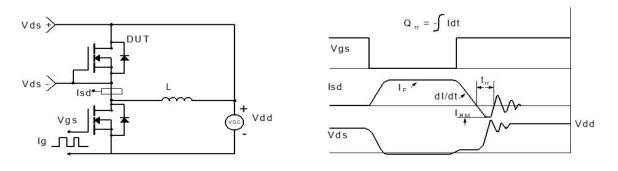


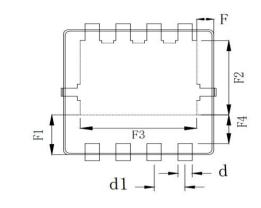
Figure 4: Diode Recovery Test Circuit & Waveform

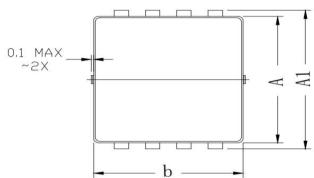
CRMQTL0312A

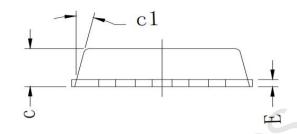




Package Mechanical Data(PDFN3.3x3.3-8L)







	COMMON DIM	MENSION (MM)	
PKG	PDFN 3.3×3.3-8L		
SYMBOL	MIN	TYP	MAX
A	3.070	3.100	3.130
A1	3. 300	3.400	3.500
b	3.070	3.100	3.130
С	0.770	0.800	0. 830
c1	= _	13°	12
d	0. 275	0. 300	0. 325
d1	0. 625	0.650	0. 675
Е	0. 144	0.152	0. 160
F	0. 300	0. 325	0. 350
F1	0.960	0. 985	1.010
F2	1. 775	1.800	1.825
F3	2. 425	2. 450	2. 475
F4	0.660	0. 685	0.710

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Contact information

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